

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am an original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled:

**Cornerplate-less Duct, Method of Manufacturing the Duct,
and Apparatus for Manufacturing Duct**

the specification of which was filed on _____ as Application No. _____

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by an amendment, if any, specifically referred to herein.

I acknowledge the duty to disclose all information known to me that is material to patentability in accordance with Title 37, Code of Federal Regulations, § 1.56.

FOREIGN PRIORITY CLAIM

I hereby claim foreign priority benefits under Title 35, United States Code § 119(a)-(d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

- ☐ no such foreign applications have been filed
☒ such foreign application have been filed as follows:

**EARLIEST FOREIGN APPLICATION(S), IF ANY FILED WITHIN 12 MONTHS
(6 MONTHS FOR DESIGN) PRIOR TO THIS U.S. APPLICATION**

Application Number	Country	Date of Filing (dd/mm/yyyy)	Priority Claimed Under 35 USC 119
✓ 2002-307314	JP	October 22, 2002	<u> x </u> Yes No <u> </u>

**ALL FOREIGN APPLICATION(S), IF ANY FILED MORE THAN 12 MONTHS
(6 MONTHS FOR DESIGN) PRIOR TO THIS U.S. APPLICATION**

Application Number	Country	Date of Filing (dd/mm/yyyy)

CLAIM FOR BENEFIT OF EARLIER U.S. PROVISIONAL APPLICATIONS

I hereby claim priority benefits under Title 35, United States Code §119(e), of any United States provisional patent application(s) listed below:

- ☒ no such U.S. provisional applications have been filed.
☐ such U.S. provisional application have been filed as follows:

Application Number	Date of Filing (dd/mm/yyyy)	Priority Claimed Under 35 USC 119
		Yes No

CLAIM FOR BENEFIT OF EARLIER U.S./PCT APPLICATION(S)

I hereby claim the benefit under Title 35, United States Code, §120 of the United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose all information that is material to patentability in accordance with Title 37, Code of Federal Regulations, §1.56 which became available to me between the filing date of the prior application and the national or PCT international filing date of this application:

- ☐ no such U.S./PCT applications have been filed.

Application Number	Date of Filing (dd/mm/yyyy)
PCT/JP03/13458	22/10/2003

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint:

All practitioners at Customer Number 04743

jointly, and each of them severally, my attorneys at law/patent agent(s), with full power of substitution, delegation and revocation, to prosecute this application, to make alterations and amendments therein, to receive the patent, and to transact all business in the U. S. Patent and Trademark Office connected therewith.

Please mail all correspondence to Richard H. Anderson, whose address is:

MARSHALL, GERSTEIN & BORUN LLP
 233 S. Wacker Drive, Suite 6300
 Sears Tower
 Chicago, Illinois 60606-6357

Please direct telephone calls to: Richard H. Anderson at (312) 474-6300.

Please direct facsimiles to: (312) 474-0448

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Full name of sole or first inventor Toshio YAMAMOTO	
Sole or first inventor's signature <i>Toshio YAMAMOTO</i>	Date June 3, 2005
Residence Osaka, Japan JPX	
Citizenship Japan	
Mailing Address c/o Obayashi Corporation 4-33, Kitahamahigashi Chuo-ku, Osaka-shi Osaka; 540-8584; JAPAN	

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Full name of second inventor, if any Mitsuru MARUKAWA	
Second inventor's signature <i>Mitsuru Marukawa.</i>	Date June 3, 2005
Residence Osaka, Japan JPX	
Citizenship Japan	
Mailing Address c/o Obayashi Corporation 4-33, Kitahamahigashi Chuo-ku, Osaka-shi Osaka; 540-8584; JAPAN	

Full name of third inventor, if any Yoshimasa YOSHIMOTO	
Third inventor's signature	Date
Residence Osaka, Japan	
Citizenship Japan	
Mailing Address c/o Osaka Office, Takasago Thermal Engineering Co., Ltd. 19-19, Chayamachi, Kita-ku, Osaka-shi Osaka 530-0013; JAPAN	

Full name of fourth inventor, if any Shozo IIZUKA	
Fourth inventor's signature	Date
Residence Himeji, Japan	
Citizenship Japan	
Mailing Address 15-29, Johokushinmachi 1-chome, Himeji-shi, Hyogo 670-0883; JAPAN	

Full name of sole or first inventor Toshio YAMAMOTO	
Sole or first inventor's signature	Date
Residence Osaka, Japan	
Citizenship Japan	
Mailing Address c/o Obayashi Corporation 4-33, Kitahamahigashi Chuo-ku, Osaka-shi Osaka; 540-8584; JAPAN	

Full name of second inventor, if any Mitsuru MARUKAWA	
Second inventor's signature	Date
Residence Osaka, Japan	
Citizenship Japan	
Mailing Address c/o Obayashi Corporation 4-33, Kitahamahigashi Chuo-ku, Osaka-shi Osaka; 540-8584; JAPAN	

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Full name of third inventor, if any Yoshimasa YOSHIMOTO	
Third inventor's signature <i>Yoshimasa Yoshimoto</i>	Date June 3, 2005
Residence Osaka, Japan JPX	
Citizenship Japan	
Mailing Address c/o Osaka Office, Takasago Thermal Engineering Co., Ltd. 19-19, Chayamachi, Kita-ku, Osaka-shi Osaka 530-0013; JAPAN	

Full name of fourth inventor, if any Shozo IIZUKA	
Fourth inventor's signature	Date
Residence Himeji, Japan	
Citizenship Japan	
Mailing Address 15-29, Johokushinmachi 1-chome, Himeji-shi, Hyogo 670-0883; JAPAN	

Full name of sole or first inventor Toshio YAMAMOTO	
Sole or first inventor's signature	Date
Residence Osaka, Japan	
Citizenship Japan	
Mailing Address c/o Obayashi Corporation 4-33, Kitahamahigashi Chuo-ku, Osaka-shi Osaka; 540-8584; JAPAN	

Full name of second inventor, if any Mitsuru MARUKAWA	
Second inventor's signature	Date
Residence Osaka, Japan	
Citizenship Japan	
Mailing Address c/o Obayashi Corporation 4-33, Kitahamahigashi Chuo-ku, Osaka-shi Osaka; 540-8584; JAPAN	

Full name of third inventor, if any Yoshimasa YOSHIMOTO	
Third inventor's signature	Date
Residence Osaka, Japan	
Citizenship Japan	
Mailing Address c/o Osaka Office, Takasago Thermal Engineering Co., Ltd. 19-19, Chayamachi, Kita-ku, Osaka-shi Osaka 530-0013; JAPAN	

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Full name of fourth inventor, if any Shozo IIZUKA	
Fourth inventor's signature <i>Shozo Iizuka</i>	Date July 19, 2005
Residence Himeji, Japan JPX	
Citizenship Japan	
Mailing Address 15-29, Johokushinmachi 1-chome, Himeji-shi, Hyogo 670-0883; JAPAN	

Attorney Docket No.: 19036/40258

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Full name of fifth inventor, if any <u>Takashi HARA</u>	
Fifth inventor's signature <u>TAKASHI HARA</u>	Date July 19, 2005
Residence <u>Himeji, Japan JPX</u>	
Citizenship <u>Japan</u>	
Mailing Address 159-1, Otsu, Abo, Himeji-shi, Hyogo 670-0944, JAPAN	